

TLX9175J

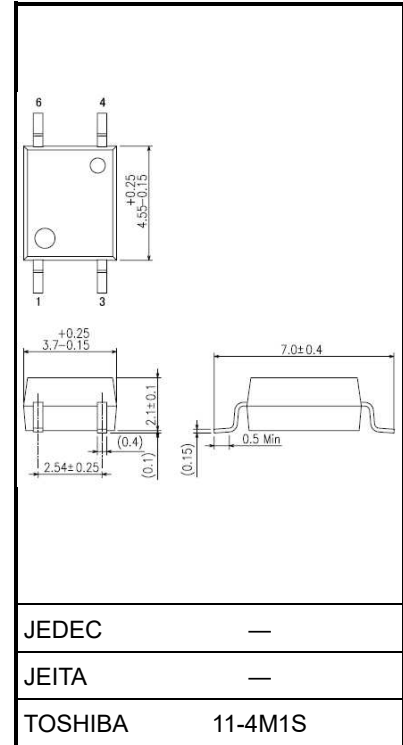
Battery Control in Automotive Equipment
 Fuel Battery Control in Automotive Equipment
 Application for Electrical Vehicle

The Toshiba TLX9175J consists of an infrared LED optically coupled to a photo-MOSFET in a SO6 package.

This coupler use high voltage MOSFET between output terminals.
 It adequate for the applications of Battery Control Systems.

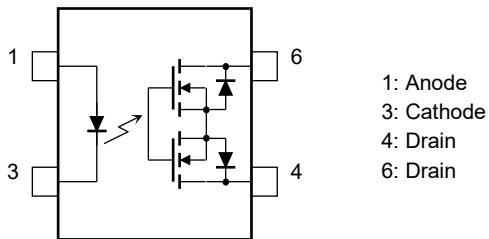
- Normally open (1-Form-A) device
- Peak off-state voltage: 600 V (min)
- Trigger LED current: 3 mA (max)
- On-state current: 15 mA (max)
- On-state resistance: 335 Ω (max)(@ t < 1 s)
- Isolation voltage: 3750 Vrms (min)
- AEC-Q101 qualified

Unit: mm



Weight: 0.08 g (typ.)

Pin Configuration (top view)



Absolute Maximum Rating (Unless otherwise specified, Ta = 25°C) (Note)

Characteristics		Symbol	Rating	Unit	
LED	Forward current	I_F	25	mA	
	Forward current derating (Ta ≥ 70 °C)	$\Delta I_F/^\circ\text{C}$	-0.18	mA/°C	
	Reverse voltage	V_R	5	V	
	Input Power Dissipation	PD	50	mW	
	Input Power Dissipation Derating (Ta ≥ 70 °C)	$\Delta PD/^\circ\text{C}$	-0.61	mW/°C	
	Junction temperature	T_j	125	°C	
Detector	Off-state output terminal voltage	V_{OFF}	600	V	
	On-state current	Ta = 25 °C	I_{ON}	15	mA
		Ta = 85 °C		11	mA
		Ta = 105 °C		7	mA
	Forward current derating	Ta ≥ 60 °C	$\Delta I_{ON}/^\circ\text{C}$	-0.16	mA/°C
		Ta ≥ 85 °C		-0.2	
	On-state current (Peak) (Note 2)	Ta = 25 °C	I_{ONpk}	80	mA
		Ta = 85 °C		50	mA
		Ta = 105 °C		25	mA
	Output power dissipation	P_O	90	mW	
	Output power dissipation derating (Ta ≥ 70 °C)	$\Delta P_O/^\circ\text{C}$	-0.9	mW/°C	
Junction temperature	T_j	125	°C		
Storage temperature	T_{stg}	-55 to 125	°C		
Operating temperature	T_{opr}	-55 to 105	°C		
Lead soldering temperature (10 s)	T_{sol}	260	°C		
Isolation voltage (AC, 60 s, R.H. ≤ 60%) (Note 1)	BV_S	3750	Vrms		

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note: This product is more sensitive than conventional products to electrostatic discharge (ESD). It is therefore all the more necessary to observe general precautions regarding ESD when handling this component.

Note 1: LED pins are shorted together. Detector pins are also shorted together.

Note 2: Exponential curve, pulse width < 1ms, f ≤ 150Hz

Recommended Operating Conditions (Note)

Characteristics	Symbol	Min	Typ.	Max	Unit
Supply voltage	V_{DD}	—	—	450	V
Forward current	I_F	10	12	20	mA
On-state current	I_{ON}	—	—	10	mA
Operating temperature	T_{opr}	-40	—	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Electrical Characteristics (Unless otherwise specified, Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
LED	Forward voltage	V _F	I _F = 10 mA	1.5	1.65	1.8	V
			I _F = 10 mA, Ta = -40 to 105 °C	1.4	—	1.95	
	Reverse current	I _R	V _R = 5 V	—	—	10	μA
	Capacitance	C _T	V = 0 V, f = 1 MHz	—	45	—	pF
Detector	Off-state current	I _{OFF}	V _{OFF} = 600 V, Ta = 25 °C	—	10	50	nA
			V _{OFF} = 600 V, Ta = 85 °C	—	—	250	
			V _{OFF} = 600 V, Ta = 105 °C	—	—	400	
	Capacitance	C _{OFF}	V _{OFF} = 0 V, f = 1 MHz	—	8.0	—	pF

Coupled Electrical Characteristics

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Trigger LED current	I _{FT}	I _{ON} = 15 mA, Ta=25 °C, t = 10 ms	—	—	3	mA
		I _{ON} = 11 mA, Ta= -40 to 85 °C, t = 10 ms	—	—	5	
		I _{ON} = 7 mA, Ta= -40 to 105 °C, t = 10 ms	—	—	8	
Return LED current	I _{FC}	I _{OFF} = 100 μA, Ta= 25 °C, t = 40 ms	0.1	—	—	mA
		I _{OFF} = 100 μA, Ta= -40 to 85 °C, t = 40 ms	0.05	—	—	
		I _{OFF} = 100 μA, Ta= -40 to 105 °C, t = 40 ms	0.05	—	—	
On-state resistance	R _{ON}	I _{ON} = 15 mA, I _F = 10 mA, Ta = 25 °C, t < 1 s	185	—	335	Ω
		I _{ON} = 11 mA, I _F = 10 mA, Ta = 85 °C, t < 1 s	310	—	510	
		I _{ON} = 7 mA, I _F = 10 mA, Ta = 105 °C, t < 1 s	400	—	650	
		I _{ON} = 15 mA, I _F = 10 mA, Ta = 25 °C, t > 60 s	—	360	—	

Isolation Characteristics (Ta = 25°C)

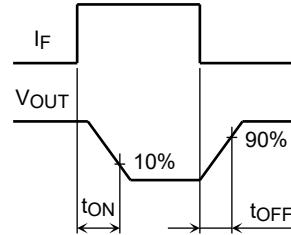
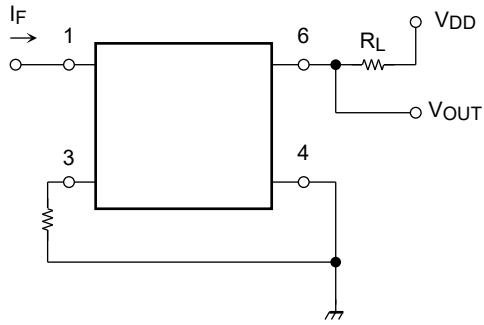
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Capacitance input to output	C _S	V _S = 0 V, f = 1 MHz	—	0.5	—	pF
Isolation resistance	R _S	V _S = 500 V, R.H. ≤ 60 %	5 × 10 ¹⁰	10 ¹⁴	—	Ω
Isolation voltage	BV _S	AC, 60 s	3750	—	—	V _{rms}

Note : Device considered a two terminal device: Pins 1 and 3 shorted together, and pins 4 and 6 shorted together.

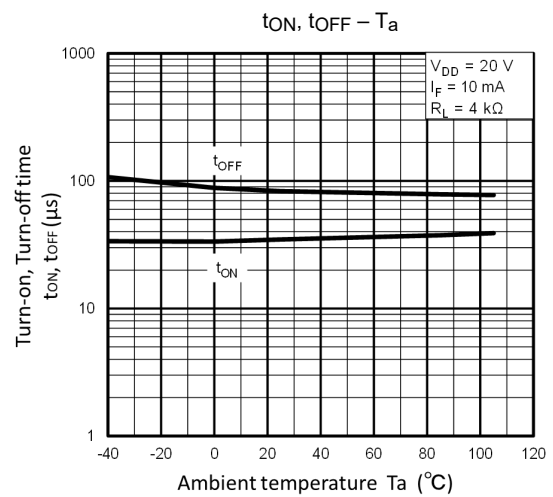
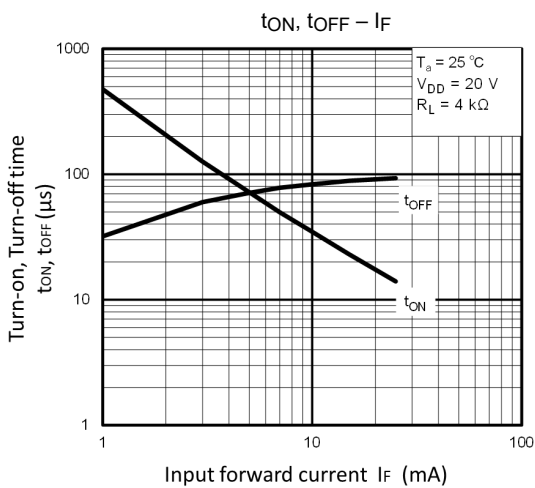
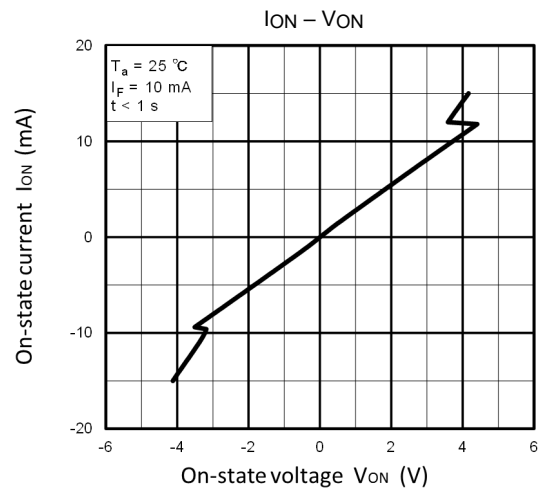
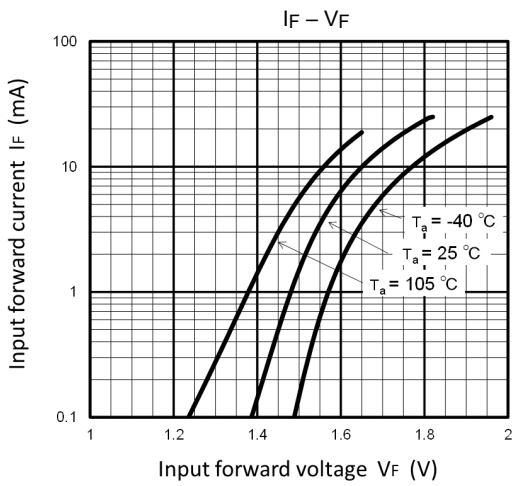
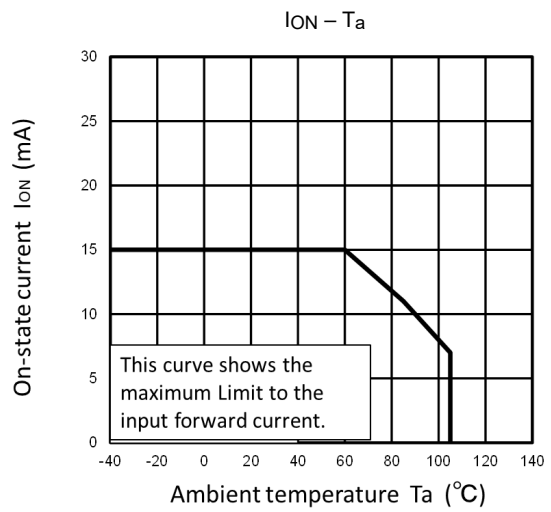
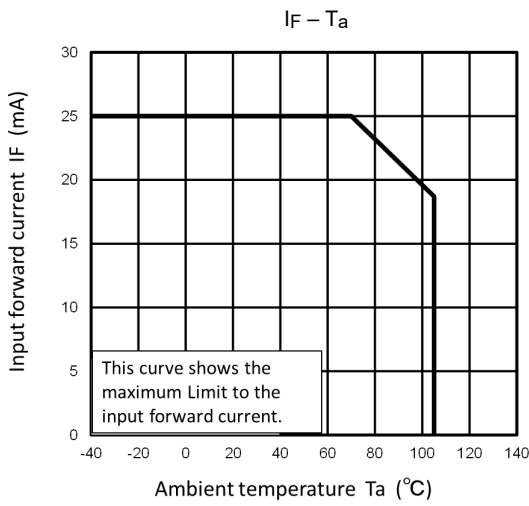
Switching Characteristics

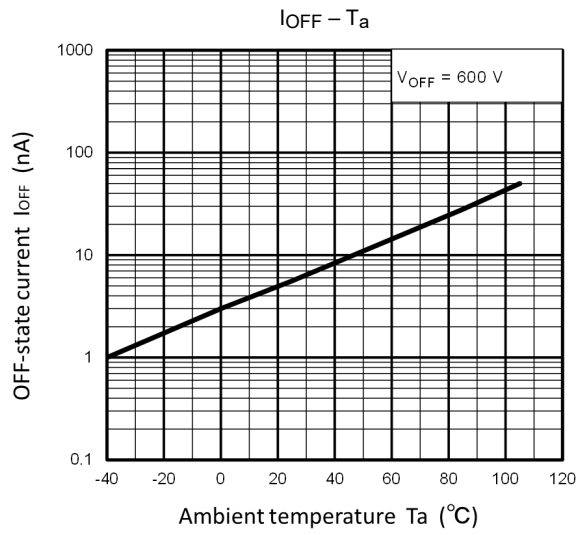
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Turn-on time	t_{ON}	$I_F = 10 \text{ mA}$, $R_L = 4 \text{ k}\Omega$, $V_{DD} = 20 \text{ V}$ (Note 1)	—	—	0.2	ms
Turn-off time	t_{OFF}					
Turn-on time	t_{ON}		—	—	0.35	ms
Turn-off time	t_{OFF}					

Note 1: Switching time test circuit



Characteristic Curves (Note)





Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise specified.

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